

EXO SWIR

exo991MGE

General

Model	exo991MGE
Product code	F002204
Product series	EXO SWIR
Status	Available

Sensor

Sensor type	Area scan
Chroma	Mono
Spectrum	SWIR, eXtended SWIR
Spectral range	400 nm to 1700 nm
Resolution	640 × 512 (0.30 MP)
Sensor model	Sony IMX991 InGaAs
Sensor architecture (material)	cmos
Shutter type(s)	Global shutter (GS)
Sensor size	3.2 × 2.56 mm (4.1 mm, Type 1/4)
Pixel size	5.00 µm × 5.00 µm

Pixel formats

Sensor bit depth	8-bit, 12-bit
Monochrome pixel formats	mono8, mono12

Imaging performance

Dynamic range	57 dB
---------------	-------

Timing and gain

Max. frame rate	260 fps
Exposure time	21 µs to 500.00 ms
Gain	0.0 dB to 42.0 dB

I/Os and power

Non-isolated lines	0 x LVDS input, 0 x LVDS output, 0 x TTL input, 0 x TTL output, 2 x 24V input, 4 x Open drain output,
Specific non-isolated lines	1 x RS232 input, 1 x RS232 output, 0 x RS422 input, 0 x RS422 output,
Opto-isolated lines	1 x Optical isolated input, 0 x Optical isolated input,
I/O connector	12-pin Hirose HR10A-10P-12S
Power supply	10 to 25VDC, Power over Ethernet
Power consumption	External: 3.5 W (typical)

Operating conditions

Operating temperature (housing)	-10 °C to 60 °C
---------------------------------	-----------------

Mechanical properties

Body dimensions (L x W x H in mm)	43 × 50 × 50
IP class	IP40
Lens mount(s)	C-Mount
Weight	138 g

On-board memory and FPGA

Image buffer (RAM)	192 MByte
Non-volatile memory (Flash)	32 MByte

Interfaces

Digital interface	gige
Interface connector	(RJ-45)
Vision standard	GigE Vision

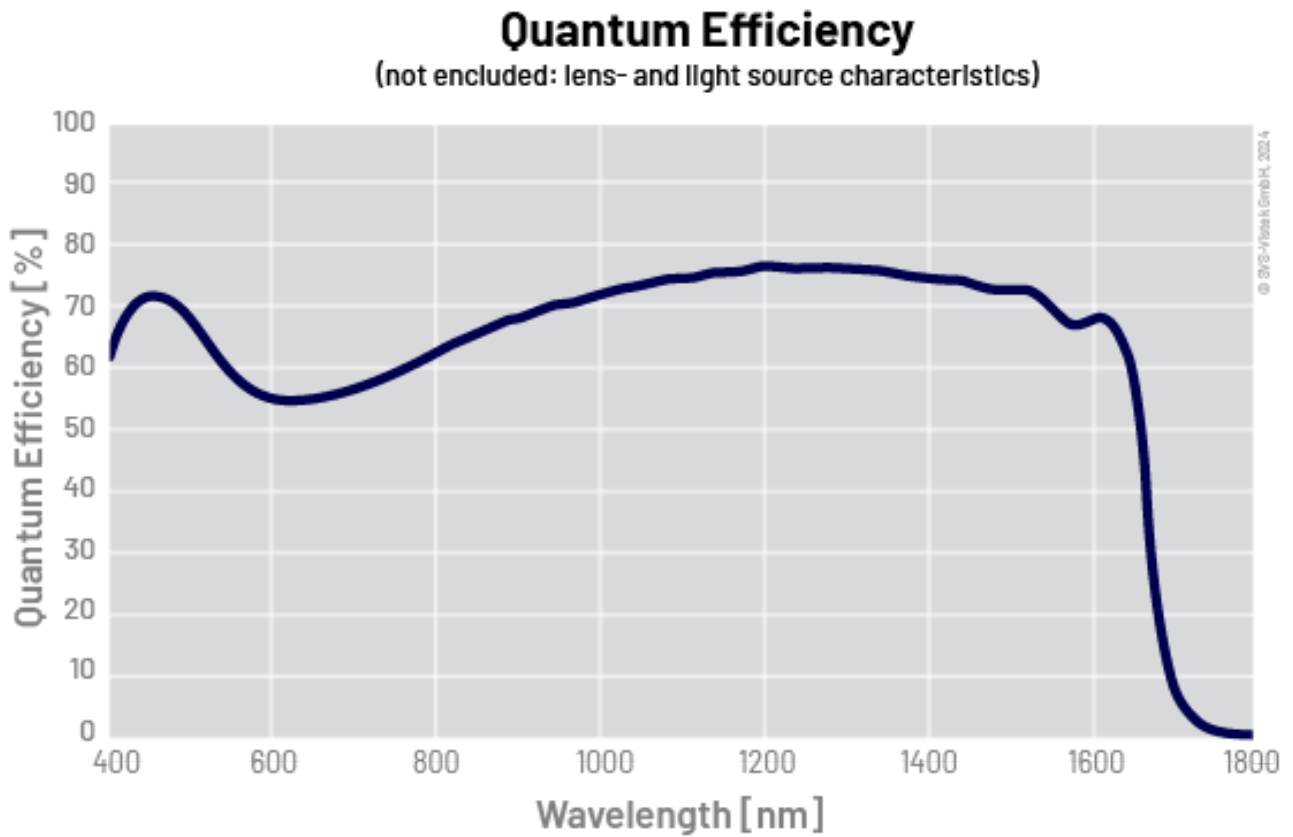
FW features - image control

Exposure modes	manual, auto
Gain modes	auto, manual
Image control features	roi, lut, mirror-image, dpc, nuc, ffc

FW features - camera control

Trigger modes/sync	internal, software, external
Camera control features	User Sets, POE, PWM(4), Sequencer,

Quantum Efficiency



Technical drawing of the front view of a square plate with a central circular hole. The plate has a square outer shape with rounded corners, a square inner shape, and a circular hole in the center. Dimensions are given in millimeters.

- Outer square side length: 50
- Inner square side length: 42.4
- Circular hole diameter: $\varnothing 30$
- Material: 1st - UN 2A
- Surface finish: 1.6 μm

0,5 sensor cover glass

48,7

46,7

44,5

42,5

8,5

0

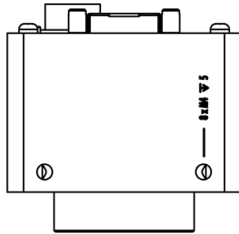
17,526
optical distance

17,696
mechanical adjustment
without compensation

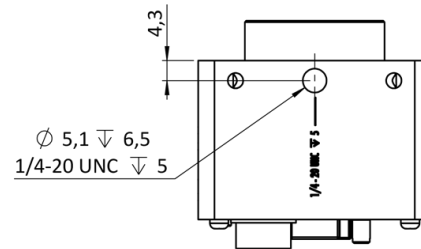
Technical drawing of the EXO 3400 device showing dimensions and mounting specifications:

- Mounting holes: 8 x Ø 3,3
- Mounting holes: M4 - 6H
- Device height: 34
- Device width: 4,3
- Device label: EXO 3400

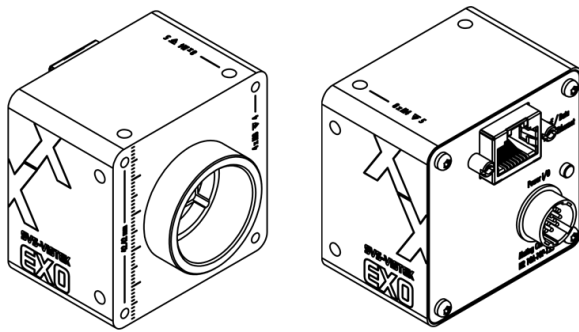
top



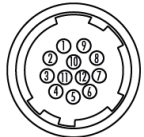
bottom



3D



I/O pin assignment

Hirose 12 Pin 	1	VIN -	(GND)	7	OUT 1	(open drain)
	2	VIN +	(10 V to 25 V DC)	8	OUT 2	(open drain)
	3	IN 4	(RXD RS232)	9	IN 3 +	(opto In +)
	4	OUT 4	(TXD RS232)	10	IN 3 -	(opto In -)
	5	IN 1	(0-24V)	11	OUT 3	(open drain)
	6	IN 2	(0-24V)	12	OUT 0	(open drain)